

### Features

- High isolation 5000 VRMS
- DC input with random-phase photo triac output
- Operating temperature range - 40 °C to 100 °C
- REACH & RoHS compliance
- MSL class 1
- Regulatory Approvals
  - UL - UL1577
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC - GB4943.1

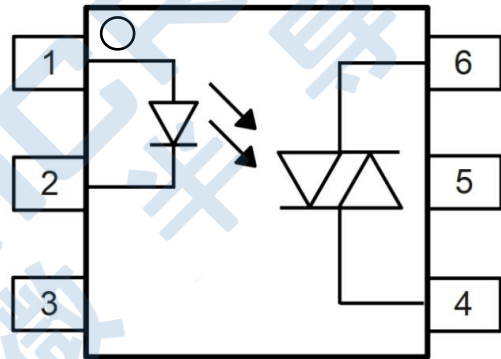
### Applications

- Solenoid/valve controls
- Lighting controls
- Motor controls
- Temperature controls
- Static AC power switches
- Solid state relays
- Interfacing microprocessors to 115 to 240VAC peripherals




### Description

The MOC302X and MOC305X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac in a plastic DIP6 package with different lead forming options.

With the robust coplanar double mold structure, MOC302X and MOC305X series provide the most stable isolation feature.



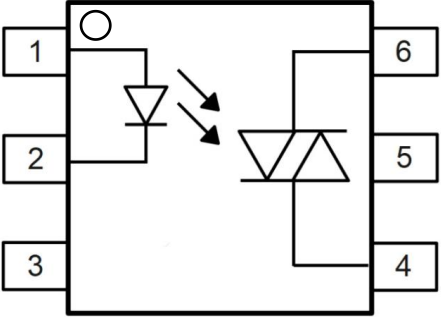
### ORDERING INFORMATION

Outline	Part Number	Package	Marking	Packing	Packing Size	Quantity
	MOC302XVPE	DIP6	MOC30XXV /YYWW A	Tube	500mm	65
	MOC305XVPE					
	MOC302XVGE	DIP6-M				
	MOC305XVGE					
	MOC302XVSE	DIP6-SL		Reel	13 "	1000
	MOC305XVSE					

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### PIN CONFIGURATION AND FUNCTIONS

	Pin	Name
	1	Anode
	2	Cathode
	3	NC
	4	Terminal
	5	Substrate
	6	Terminal

### ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit	Note
INPUT				
Forward Current	$I_F$	60	mA	
Reverse Voltage	$V_R$	6	V	
Junction Temperature	$T_j$	125	°C	
Input Power Dissipation	$P_i$	100	mW	
OUTPUT				
Off-state Output Terminal Voltage	MOC302X	400	V	
	MOC305X	600		
Peak Repetitive Surge Current PW=100μs, 120pps	$I_{TSM}$	1	A	
Junction Temperature	$T_j$	125	°C	
Output Power Dissipation	$P_o$	300	mW	
COMMON				
Total Power Dissipation	$P_{tot}$	400	mW	
Isolation Voltage	$V_{iso}$	5000	V <sub>rms</sub>	1
Operating Temperature	$T_{opr}$	-40~100	°C	
Storage Temperature	$T_{stg}$	-55~125	°C	
Soldering Temperature	$T_{sol}$	260	°C	2

Note 1. AC For 1 Minute, R.H. = 40 ~ 60%

Note 2. For 10 seconds

**ELECTRICAL OPTICAL CHARACTERISTICS(T<sub>a</sub>=25°C)**

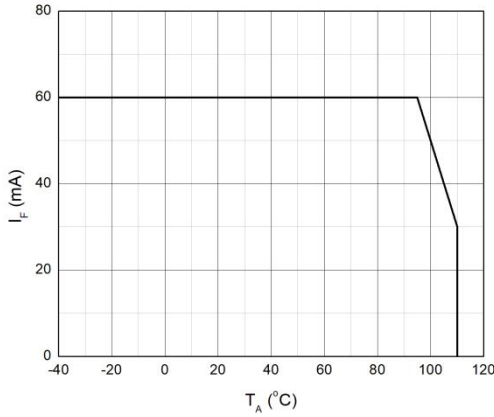
Parameter		Symbol	Min.	Typ.	Max.	Unit	Test Condition	Note
INPUT								
Forward Voltage		V <sub>F</sub>	-	1.24	1.4	V	I <sub>F</sub> =10mA	
Reverse Current		I <sub>R</sub>	-	-	10	μA	V <sub>R</sub> =6V	
Input Capacitance		C <sub>in</sub>	-	8.5	250	pF	V=0, f=1kHz	
OUTPUT								
Peak Off-state Current, Either Direction		I <sub>DRM</sub>	-	-	100	nA	V <sub>DRM</sub> =Rated V <sub>DRM</sub> I <sub>F</sub> =0	3
Peak On-state Voltage, Either Direction		V <sub>TM</sub>	-	1.58	2.5	V	I <sub>TM</sub> =100mA	
Critical Rate of Rise of Off-state Voltage		dv/dt	1000	-	-	V/μs	V <sub>PEAK</sub> =Rated V <sub>DRM</sub>	4
TRANSFER CHARACTERISTICS								
LED Trigger Current	MOC3021/3051	I <sub>FT</sub>	-	-	15	mA	Terminal Voltage = 3V I <sub>TM</sub> =100mA	
	MOC3022/3052		-	-	10			
	MOC3023/3053		-	-	5			
Holding Current		I <sub>H</sub>	-	257	-	μA		
Isolation Resistance		R <sub>iso</sub>	10 <sup>12</sup>	10 <sup>14</sup>	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C <sub>IO</sub>	-	0.8	-	pF	V=0, f=1MHz	

Note3. Test voltage must be applied within dv/dt rating.

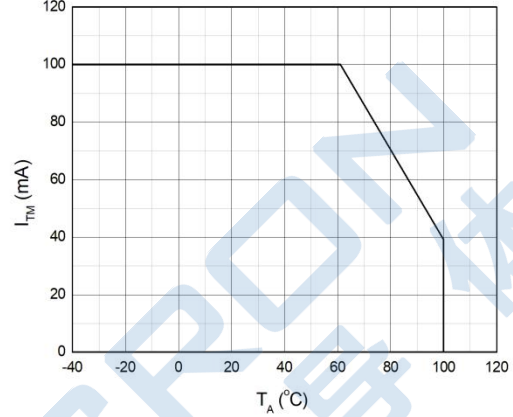
Note4. Refer to Fig.15 & Fig.16

**CHARACTERISTIC CURVES**

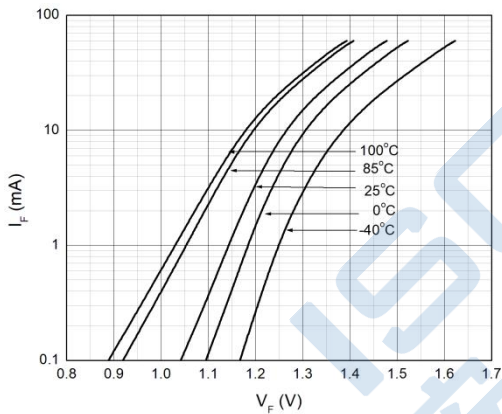
**Fig.1 Forward Current vs. Ambient Temperature**



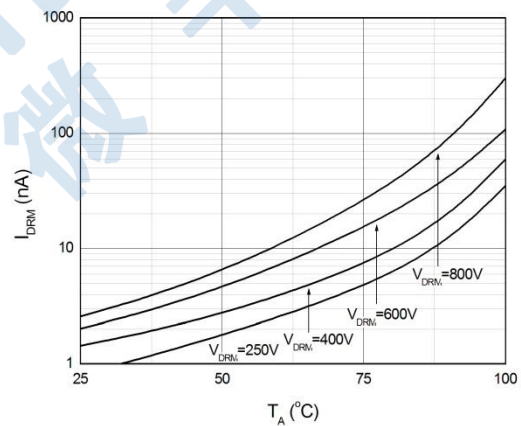
**Fig.2 On-state Terminal Current vs. Ambient Temperature**



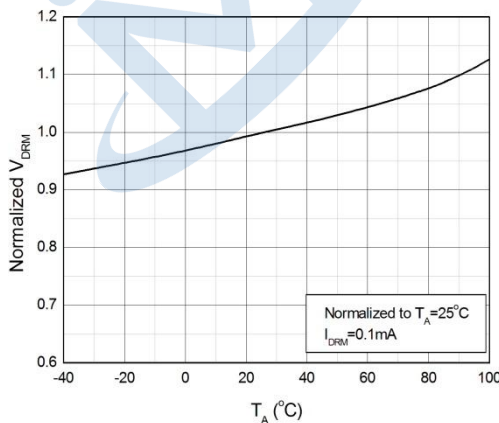
**Fig.3 Forward Current vs. Forward Voltage**



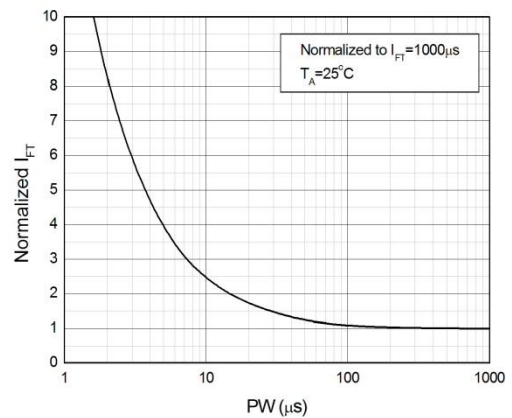
**Fig.4 Off-state Terminal Current vs. Ambient Temperature**



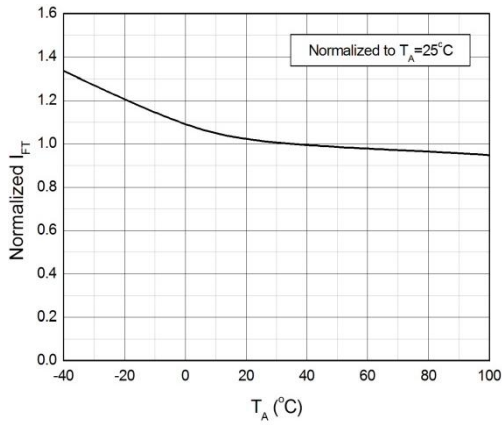
**Fig.5 Normalized Off-state Terminal Voltage vs. Ambient Temperature**



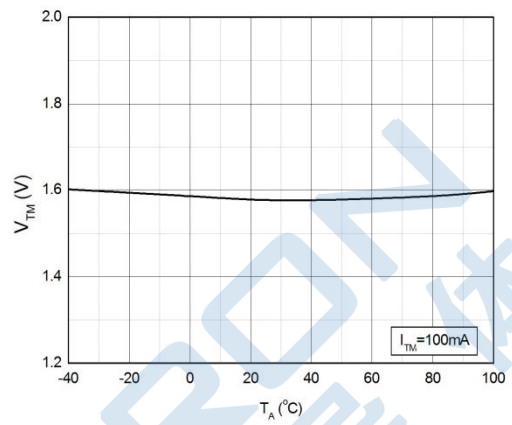
**Fig.6 Normalized Trigger Current vs. LED Trigger Pulse Width**



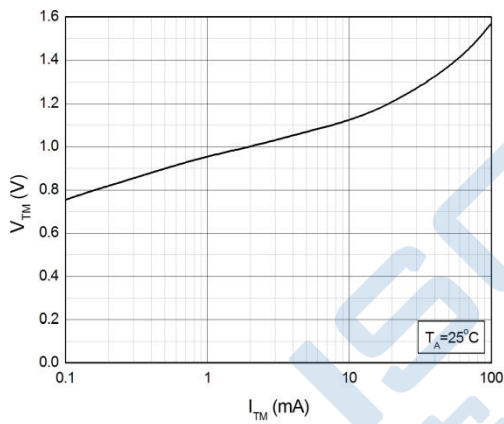
**Fig.7 Normalized Trigger Current vs. Ambient Temperature**



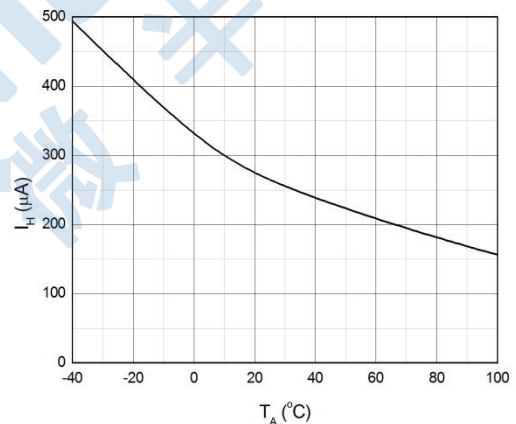
**Fig.8 On-state Terminal Voltage vs. Ambient Temperature**



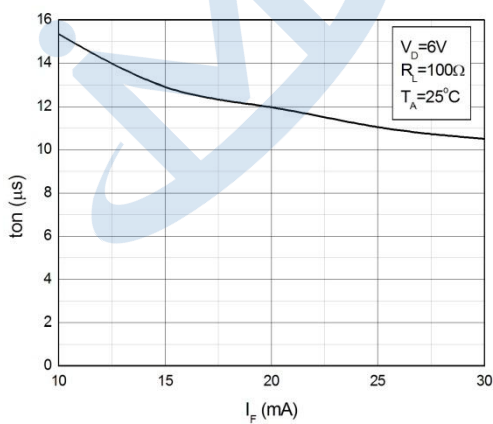
**Fig.9 On-state Terminal Voltage vs. On-state Terminal Current**



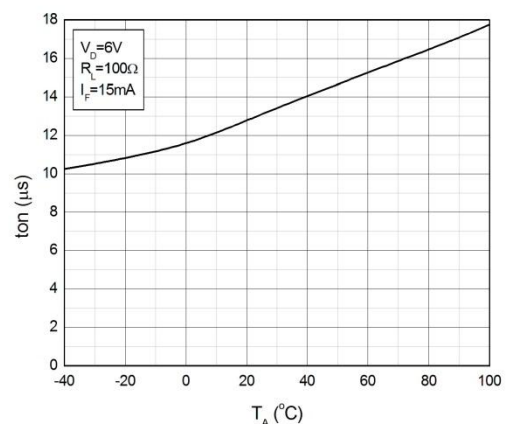
**Fig.10 Holding Current vs. Ambient Temperature**



**Fig.11 Turn On Time vs. Forward Current**



**Fig.12 Turn On Time vs. Ambient Temperature**

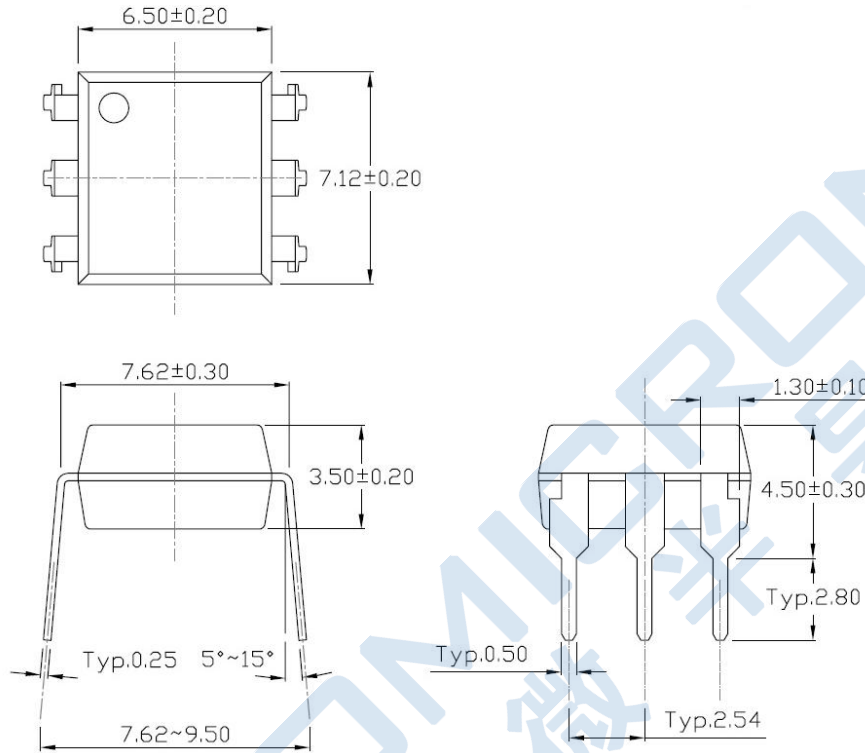


**TEST CIRCUITS**

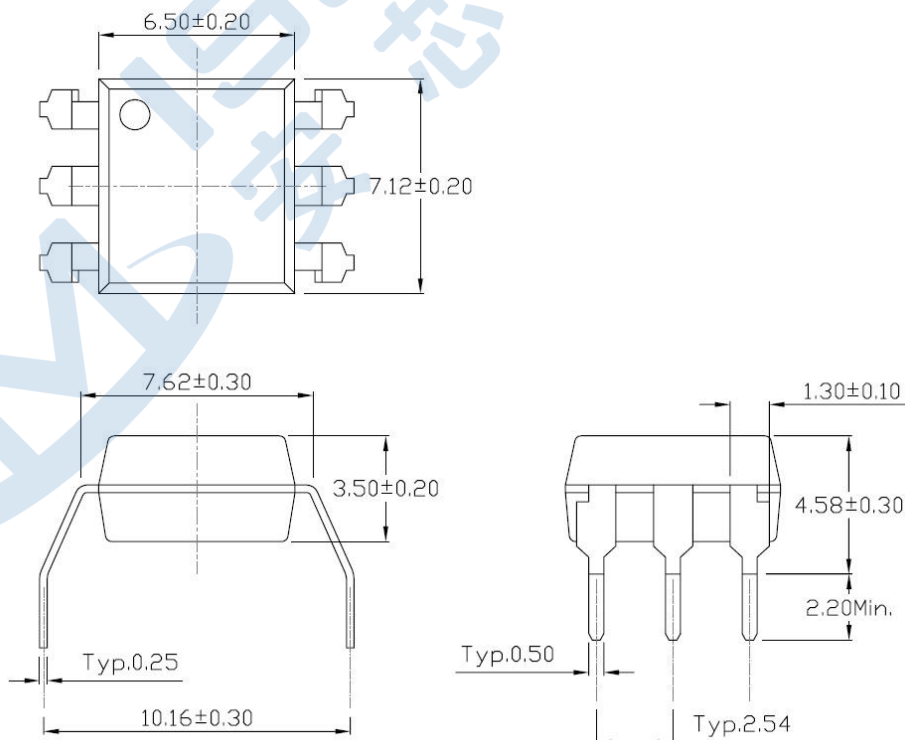
Fig.13 Test Circuits of Turn On Time	Fig.14 Waveforms of Turn On Time
Fig.15 Test Circuits of dV/dt	
Fig.16 Waveforms of dv/dt	
$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$	

**PACKAGE DIMENSIONS**

**Standard DIP – Through Hole (P Type)**

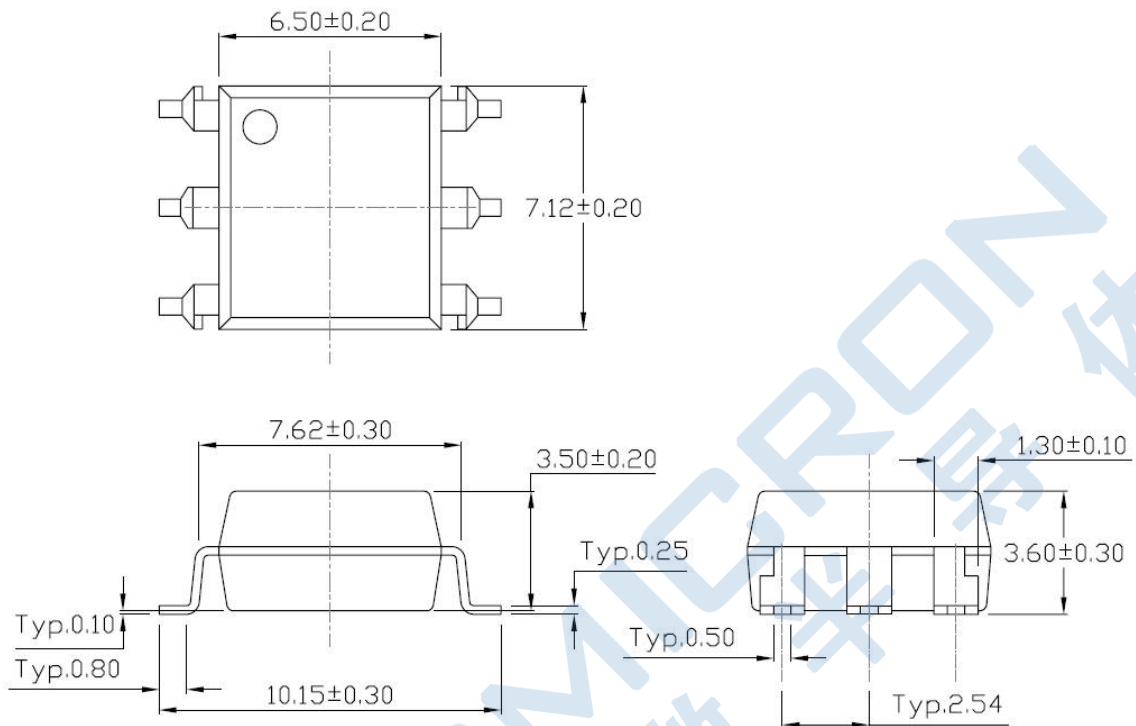


**Gullwing (400mil) Lead Forming – Through Hole (M Type)**





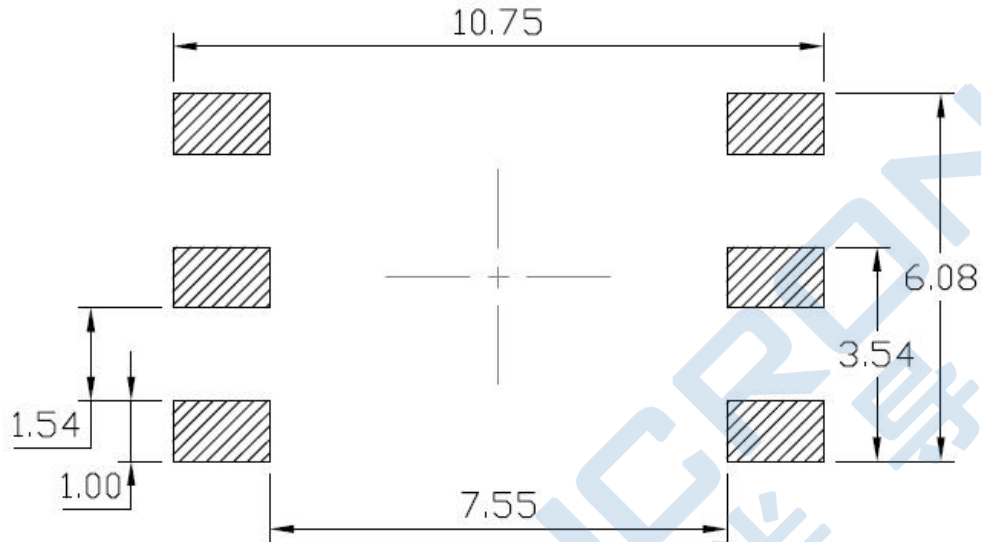
**Surface Mount (Low Profile) Lead Forming (S type)**



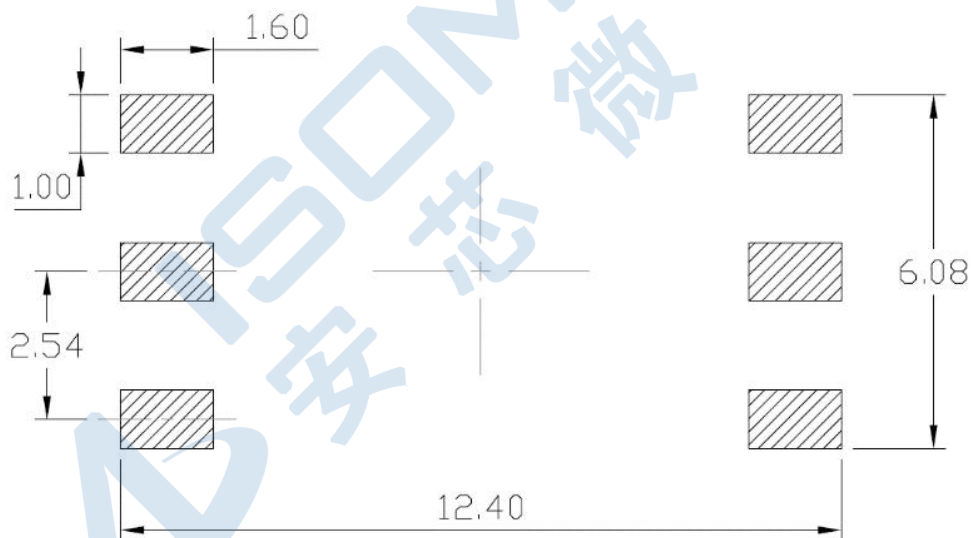
- Dimensions in mm unless otherwise stated

**RECOMMENDED SOLDER MASK**

**Surface Mount (Low Profile) Lead Forming**



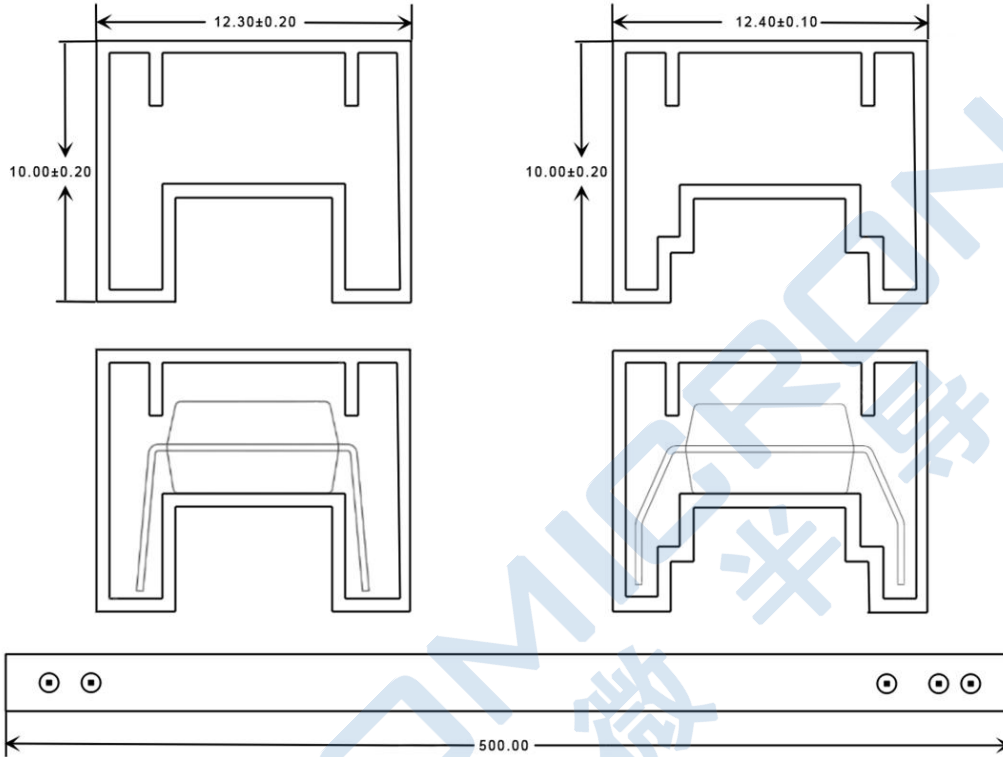
**Surface Mount (Gullwing) Lead Forming**



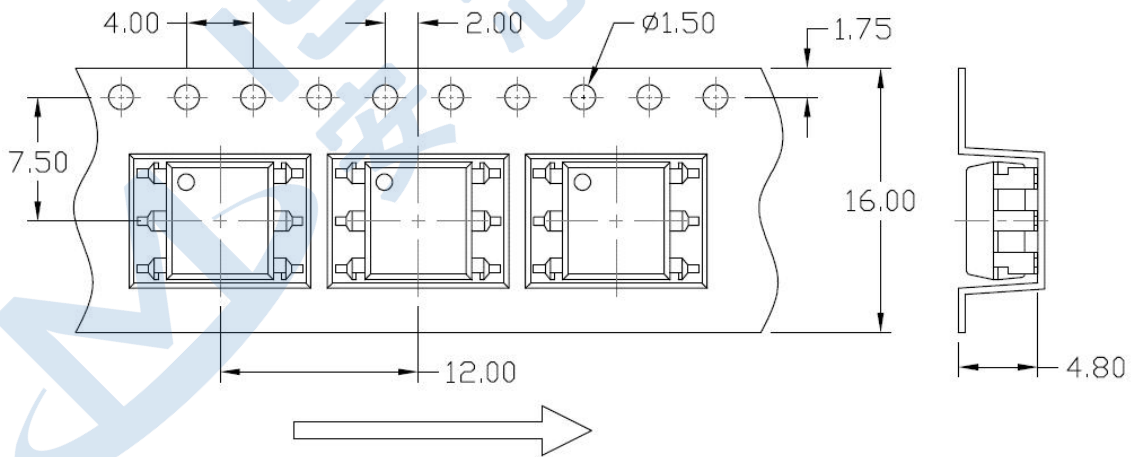
- Dimensions in mm unless otherwise stated

**CARRIER TAPE SPECIFICATIONS**

**Option DIP-Standard & DIP-M**



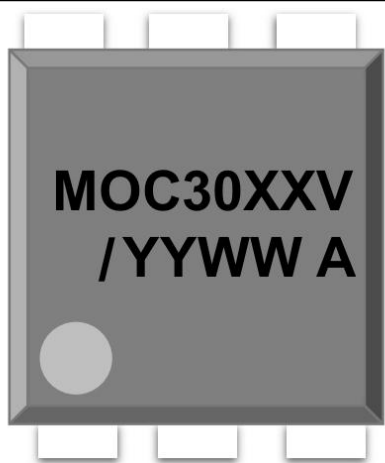
**Option SM-SL**



● Dimensions in mm unless otherwise stated

**ORDERING AND MARKING INFORMATION**

**Marking Information**



**MOC** : Product Series  
**30XX** : Part Number  
**V** : VDE Option  
**/** : ISOMICRON  
**YY** : Fiscal Year  
**WW** : Work Week  
**A** : Manufacturing Code

**Order Code**

**MOC 30XX X X X**

**Product Series**

**Part Number**

**Halogen Free**

E: Halogen-free, Lead-free  
 Z: Halogen, Lead-free

**Lead Forming**

P: DIP-Standard  
 G: DIP-M  
 S: SM-SL

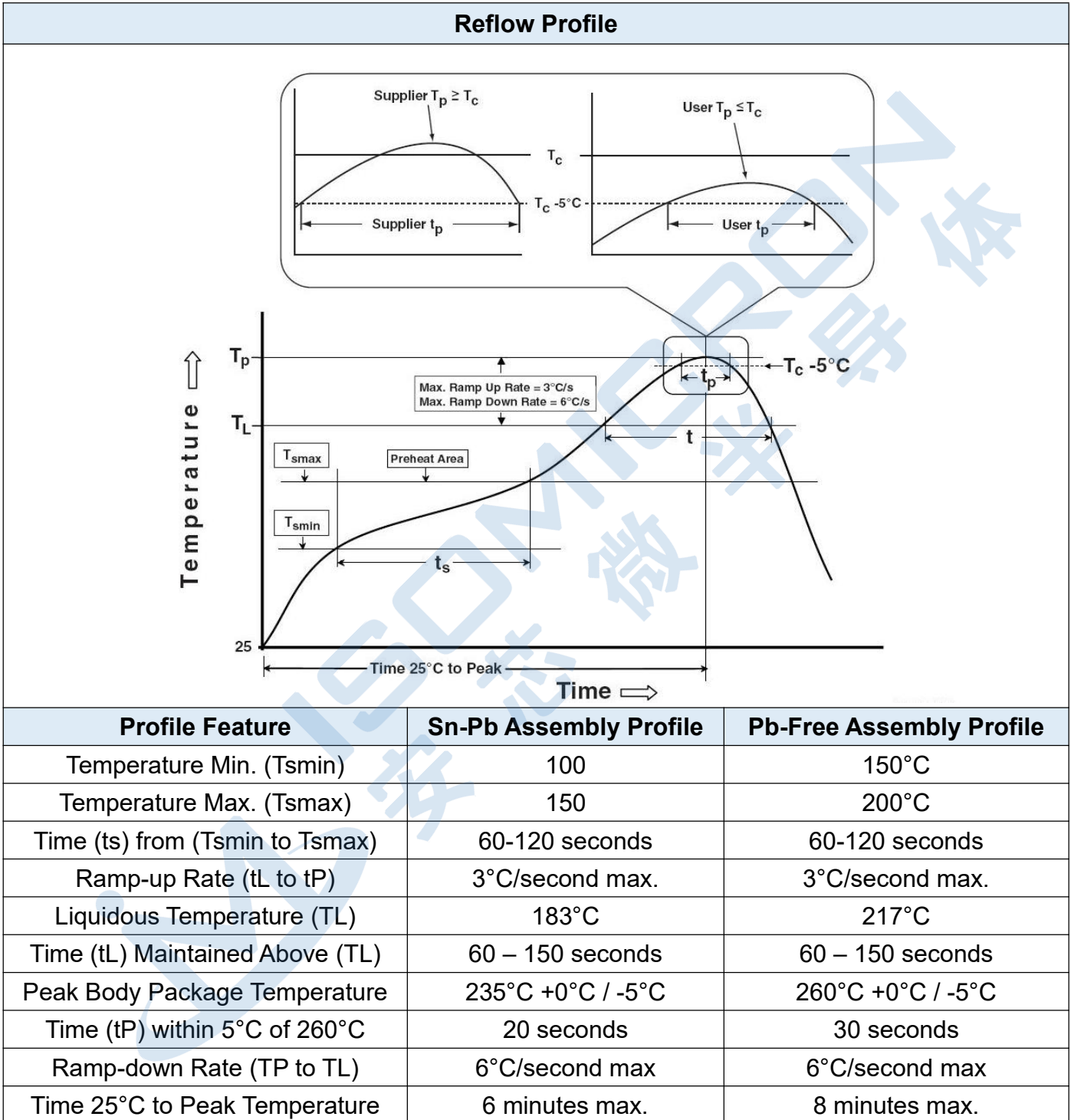
**VDE Option**

V: VDE approval  
 None

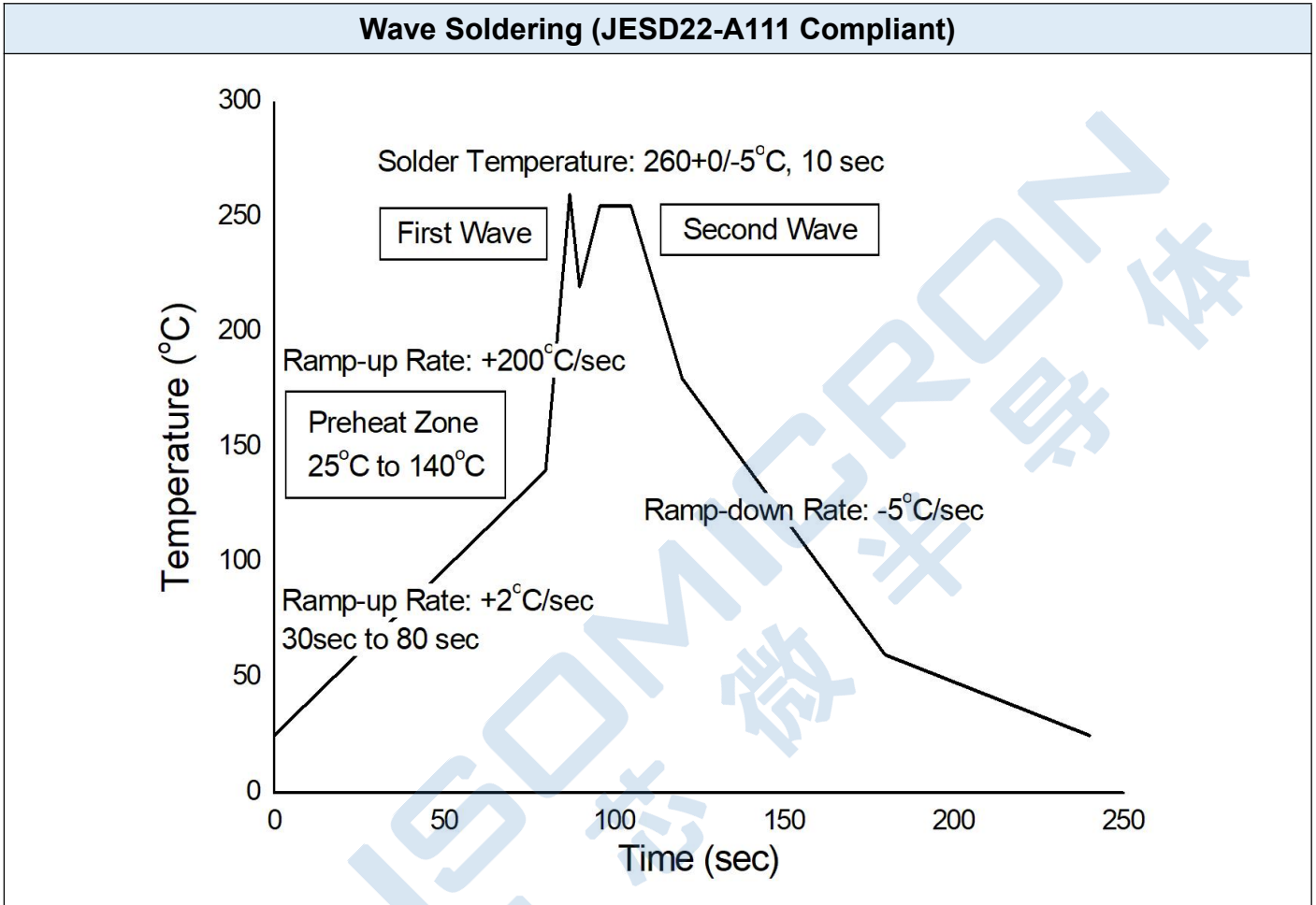
**Packing Quantity**

Option	Quantity	Quantity – Inner box	Quantity – Outer box
DIP-Standard	65 Units/Tube	20 Tubes/Inner box	6 Inner box/Outer box = 7.8k Units
DIP-M	65 Units/Tube	20 Tubes/Inner box	6 Inner box/Outer box = 7.8k Units
SM-SL	1000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 10k Units

**REFLOW INFORMATION**



**TEMPERATURE PROFILE OF SOLDERING**



- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.

## DISCLAIMER

- ISOMICRON is continually improving the quality, reliability, function and design. ISOMICRON reserves the right to make changes without further notices.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact ISOMICRON sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify ISOMICRON's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.